

# 2SD1892

Silicon NPN triple diffusion planar type Darlington

For power amplification

Complementary to 2SB1252

## ■ Features

- Optimum for 35W HiFi output
- High forward current transfer ratio  $h_{FE}$ : 5000 to 30000
- Low collector to emitter saturation voltage  $V_{CE(sat)}$ : <2.5V
- Full-pack package which can be installed to the heat sink with one screw

## ■ Absolute Maximum Ratings ( $T_C=25^\circ\text{C}$ )

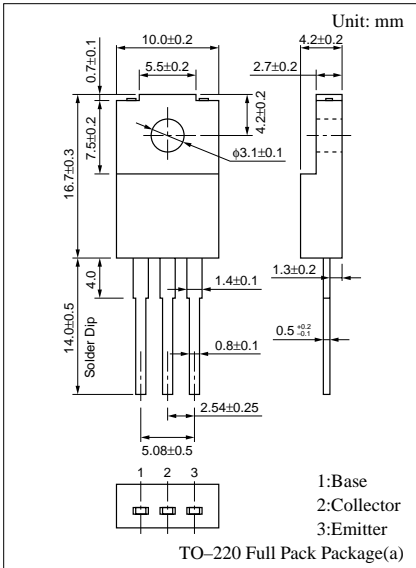
Parameter	Symbol	Ratings	Unit
Collector to base voltage	$V_{CBO}$	120	V
Collector to emitter voltage	$V_{CEO}$	100	V
Emitter to base voltage	$V_{EBO}$	5	V
Peak collector current	$I_{CP}$	8	A
Collector current	$I_C$	5	A
Collector power dissipation	$P_C$	45	W
		2	W
Junction temperature	$T_j$	150	$^\circ\text{C}$
Storage temperature	$T_{stg}$	-55 to +150	$^\circ\text{C}$

## ■ Electrical Characteristics ( $T_C=25^\circ\text{C}$ )

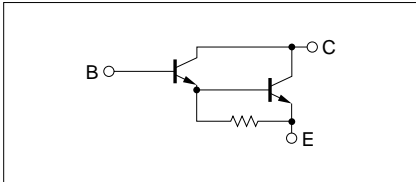
Parameter	Symbol	Conditions	min	typ	max	Unit
Collector cutoff current	$I_{CBO}$	$V_{CB} = 120\text{V}, I_E = 0$			100	$\mu\text{A}$
	$I_{CEO}$	$V_{CE} = 100\text{V}, I_B = 0$			100	$\mu\text{A}$
Emitter cutoff current	$I_{EBO}$	$V_{EB} = 5\text{V}, I_C = 0$			100	$\mu\text{A}$
Collector to emitter voltage	$V_{CEO}$	$I_C = 30\text{mA}, I_B = 0$	100			V
Forward current transfer ratio	$h_{FE1}$	$V_{CE} = 5\text{V}, I_C = 1\text{A}$	2000			
	$h_{FE2}^*$	$V_{CE} = 5\text{V}, I_C = 4\text{A}$	5000		30000	
Collector to emitter saturation voltage	$V_{CE(sat)}$	$I_C = 4\text{A}, I_B = 4\text{mA}$			2.5	V
Base to emitter saturation voltage	$V_{BE(sat)}$	$I_C = 4\text{A}, I_B = 4\text{mA}$			3.0	V
Transition frequency	$f_T$	$V_{CE} = 10\text{V}, I_C = 0.5\text{A}, f = 1\text{MHz}$		20		MHz
Turn-on time	$t_{on}$	$I_C = 4\text{A}, I_{B1} = 4\text{mA}, I_{B2} = -4\text{mA}, V_{CC} = 50\text{V}$		2.5		$\mu\text{s}$
Storage time	$t_{stg}$			3.5		$\mu\text{s}$
Fall time	$t_f$			1.0		$\mu\text{s}$

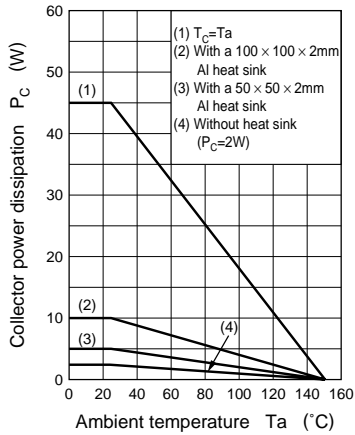
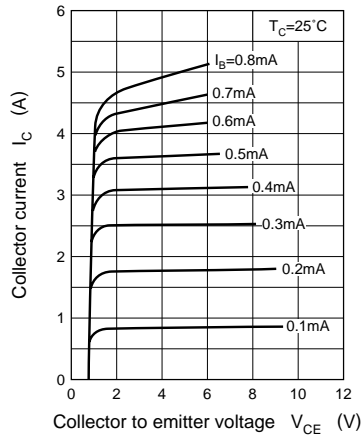
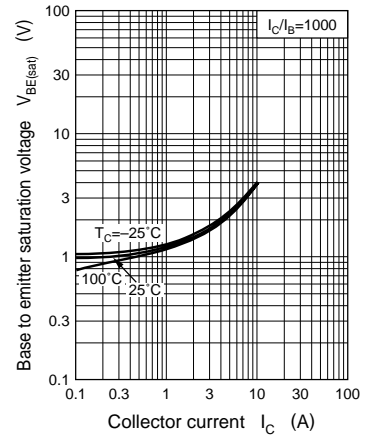
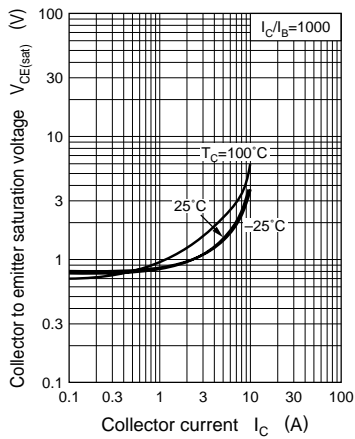
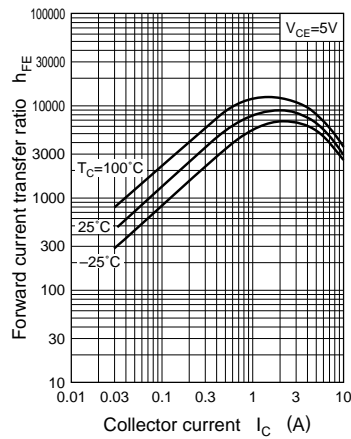
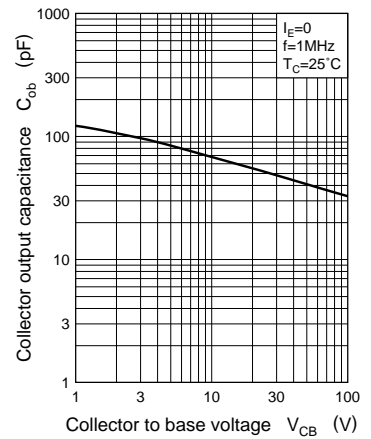
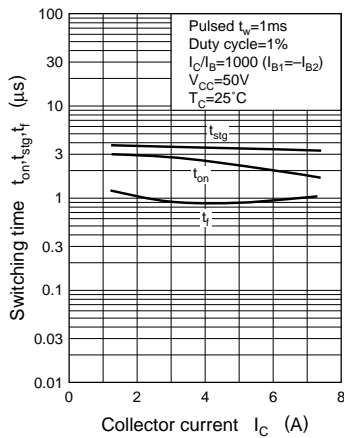
\* $h_{FE2}$  Rank classification

Rank	Q	P
$h_{FE2}$	5000 to 15000	8000 to 30000

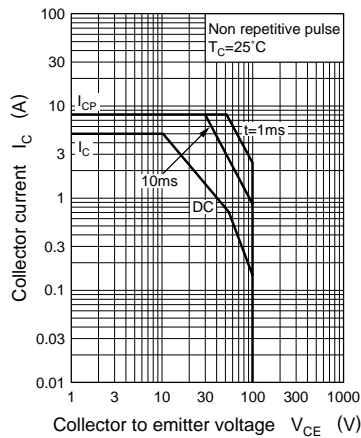


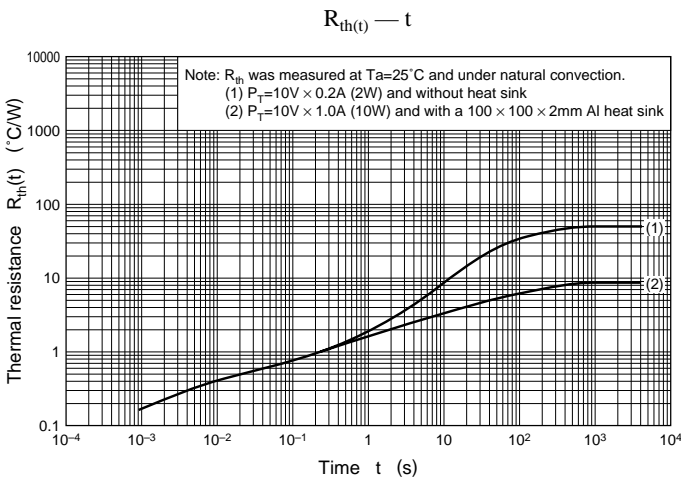
## Internal Connection



$P_C - T_a$  $I_C - V_{CE}$  $V_{BE(\text{sat})} - I_C$  $V_{CE(\text{sat})} - I_C$  $h_{FE} - I_C$  $C_{ob} - V_{CB}$  $t_{on}, t_{stg}, t_f - I_C$ 

Area of safe operation (ASO)





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